

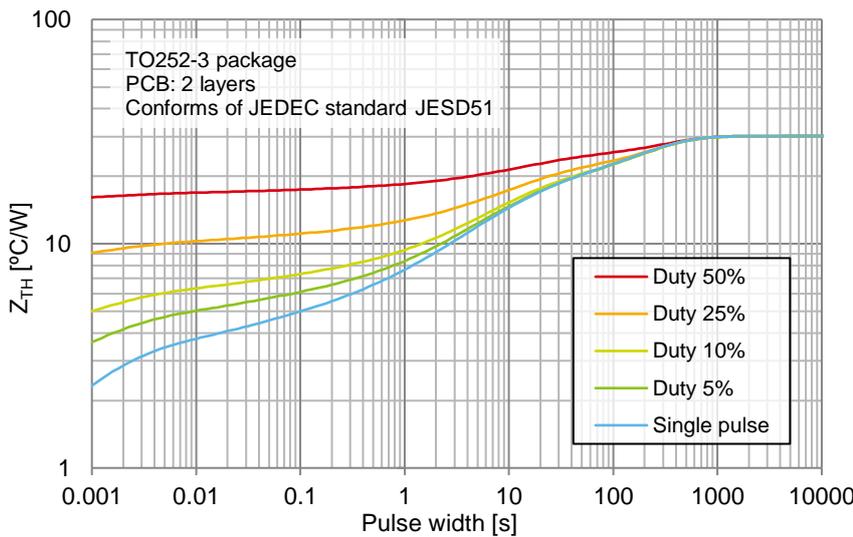
Power Devices

Method for Calculating Junction Temperature from Transient Thermal Resistance Data

The value of thermal resistance can be used to estimate the junction temperature of power devices. However, the value of transient thermal resistance must be used if the power loss varies with time. This application note explains how to calculate the junction temperature from the transient thermal resistance data as a simplified estimate during the initial stage of thermal design.

Transient thermal resistance data

Figure 1 shows an example of the transient thermal resistance data.



Graph descriptions

- The X-axis represents the pulse width, which is the time during which the power is applied to a device.
- The Y-axis represents the value of the transient thermal resistance.
- The multiple curves represent the transient thermal resistance data.
- The difference among the multiple curves indicates the difference in the duty ratios of the power application pulses. Figure 2 shows the waveforms showing the pulse widths and the duty ratios used for the measurement.

Figure 1. Example of the transient thermal resistance data

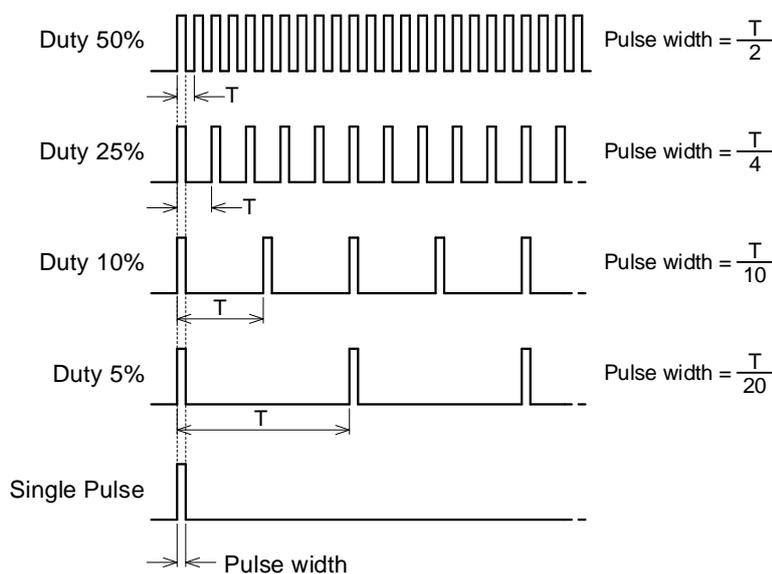


Figure 2. Waveforms showing the pulse widths and the duty ratios used for the measurement

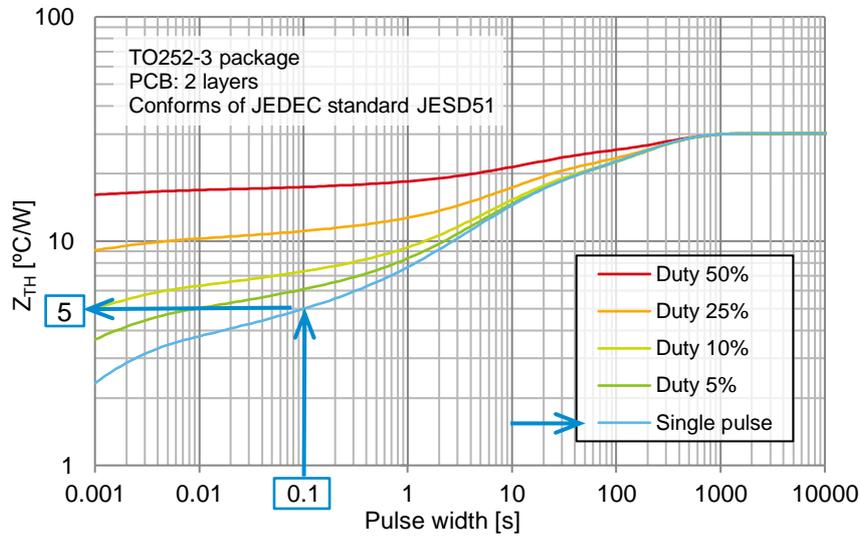
How to calculate the junction temperature

Step 1. Check the pulse width and the duty ratio of the power applied to the device and record the values.

Example: Pulse width = 100 [ms]
 Duty ratio = *Single Pulse*

Step 2. Using the values recorded above, read the value of the transient thermal resistance from the graph.

Example: Transient thermal resistance $Z_{TH} = 5 [^{\circ}C/W]$



Step 3. Calculate the junction temperature (T_j) using the following equation.

$$T_j = T_A + Z_{TH} \times P \quad [^{\circ}C]$$

where

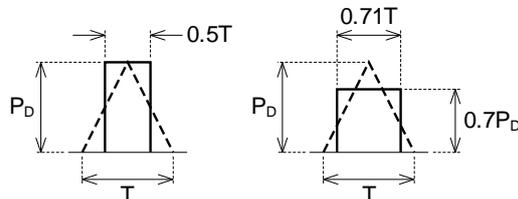
T_A : Ambient temperature [$^{\circ}C$]

Z_{TH} : Transient thermal resistance between junction and ambient environment [$^{\circ}C/W$]

P : Device power loss [W]

- Calculate or measure the total loss over time.
- References: Application Note "[Calculating Power Loss from Measurement Waveform](#)"
 Application Note "[Calculation of Power Dissipation in Switching Circuit](#)"

- The data of the transient thermal resistance is obtained by applying the power as a square wave. Therefore, if the actual power waveform is not square, it must be approximated by a square wave. For example, if the waveform to be converted is close to triangular, it can be approximated as shown in the figure below. The left shows an example where the waveform is approximated with the same peak value and the pulse width of 0.5 T. The right shows an example where the waveform is approximated with the peak value of 0.7 P_D and the pulse width of 0.71 T. Both give the same area.



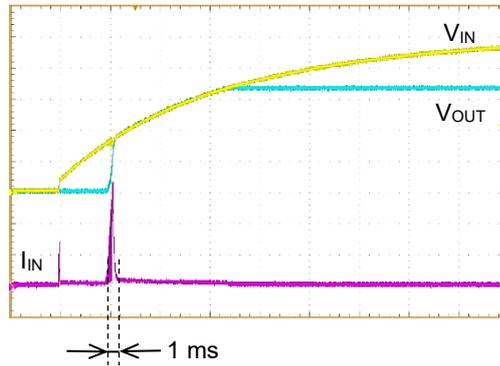
Triangular waveform approximated by a square wave

Calculation example 1

For phenomena that occur only once in a short time (for example, inrush current flowing to charge capacitors during startup of the circuit), estimate the junction temperature using the curve of “Single pulse”.

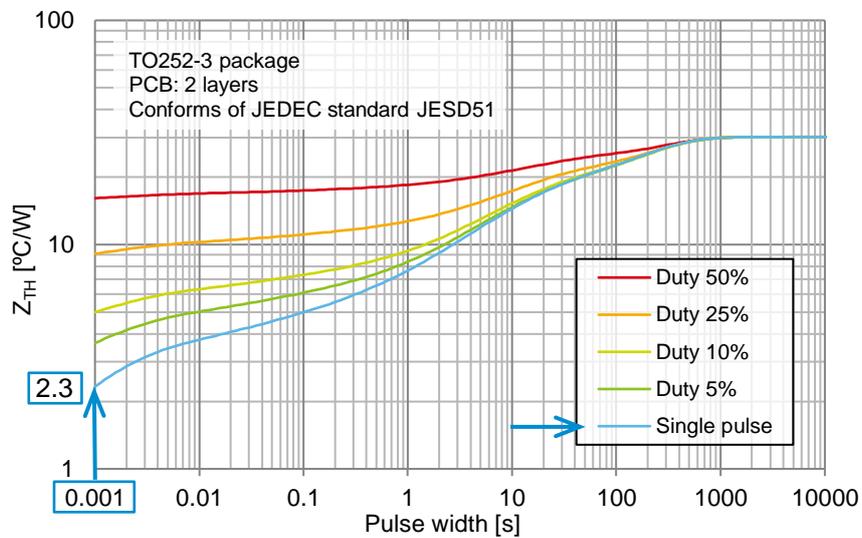
Step 1. Check the pulse width during which a high power occurs in a short time, and record the value.

Example: Pulse width = 1 [ms]



Step 2. Using the values recorded above, read the value of the transient thermal resistance from the graph.

Example: Transient thermal resistance $Z_{TH} = 2.3$ [°C/W]



Step 3. Calculate the junction temperature (T_J) using the following equation.

$$T_J = T_A + Z_{TH} \times P \text{ [°C]}$$

where

T_A : Ambient temperature [°C]

Z_{TH} : Transient thermal resistance between junction and ambient environment [°C/W]

P : Device power loss [W]

For example, if T_A and P are described with the following conditions, T_J can be calculated with the following equation.

$$T_A = 60 \text{ [°C]}$$

$$P = 10 \text{ [W]} \text{ (calculated or measured)}$$

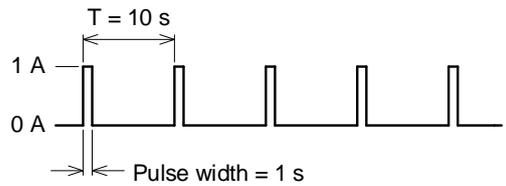
$$T_J = 60 + 2.3 \times 10 = 83 \text{ [°C]}$$

Calculation example 2

If the circuit is operated intermittently between ON and OFF, estimate the junction temperature using the curves of “Duty xx%”.

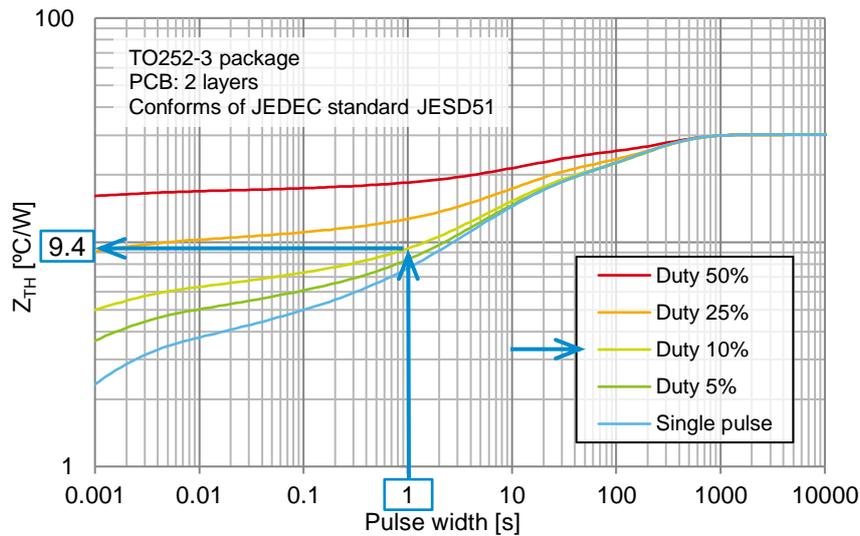
Step 1. Check the pulse width and the duty ratio where the power loss occurs, and record the values.

Example: Pulse width = 1 [s]
 Duty ratio = 10 [%]



Step 2. Using the values recorded above, read the value of the transient thermal resistance from the graph.

Example: Transient thermal resistance $Z_{TH} = 9.4 [^{\circ}C/W]$



Step 3. Calculate the junction temperature (T_J) using the following equation.

$$T_J = T_A + Z_{TH} \times P \quad [^{\circ}C]$$

where

T_A : Ambient temperature [$^{\circ}C$]

Z_{TH} : Transient thermal resistance between junction and ambient environment [$^{\circ}C/W$]

P : Device power loss [W]

For example, if T_A and P are described with the following conditions, T_J can be calculated with the following equation.

$$T_A = 60 [^{\circ}C]$$

$$P = 2 [W] \text{ (calculated or measured)}$$

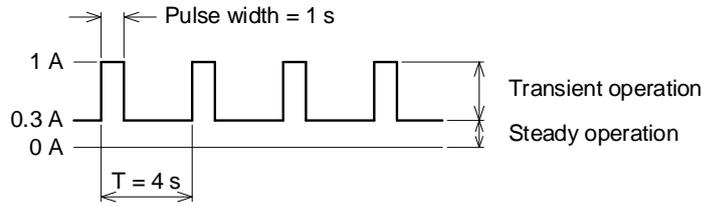
$$T_J = 60 + 9.4 \times 2 = 78.8 [^{\circ}C]$$

Calculation example 3

If the circuit is operated intermittently with varying operation conditions, estimate the junction temperature with the values combining the steady and transient operations.

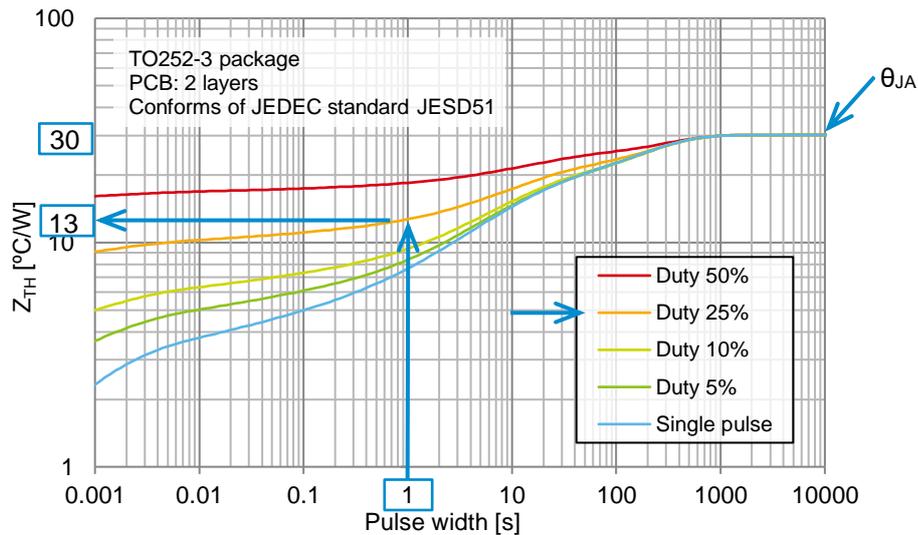
Step 1. Check the pulse width and the duty ratio where the power loss occurs, and record the values.

Example: Pulse width = 1 [s]
Duty ratio = 25 [%]



Step 2. Using the values recorded above, read the value of the transient thermal resistance from the graph. Next, read the thermal resistance (θ_{JA}) during the steady operation. The value of θ_{JA} is obtained from the right endpoint of the curve.

Example: Transient thermal resistance $Z_{TH} = 13$ [°C/W], thermal resistance during the steady operation $\theta_{JA} = 30$ [°C/W]



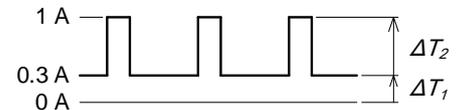
Step 3. Calculate the increase in temperature during the steady operation using the following equation.

$$\Delta T_1 = \theta_{JA} \times P_1 \quad [^{\circ}\text{C}]$$

where

θ_{JA} : Thermal resistance between junction and ambient atmosphere [°C/W]

P_1 : Device during the steady operation power loss [W]



Range of temperature calculation

Next, calculate the increase in temperature during the transient operation.

$$\Delta T_2 = Z_{TH} \times (P_2 - P_1) \quad [^{\circ}\text{C}]$$

where

Z_{TH} : Transient thermal resistance between junction and ambient environment [°C/W]

P_2 : Device during the transient operation power loss [W]

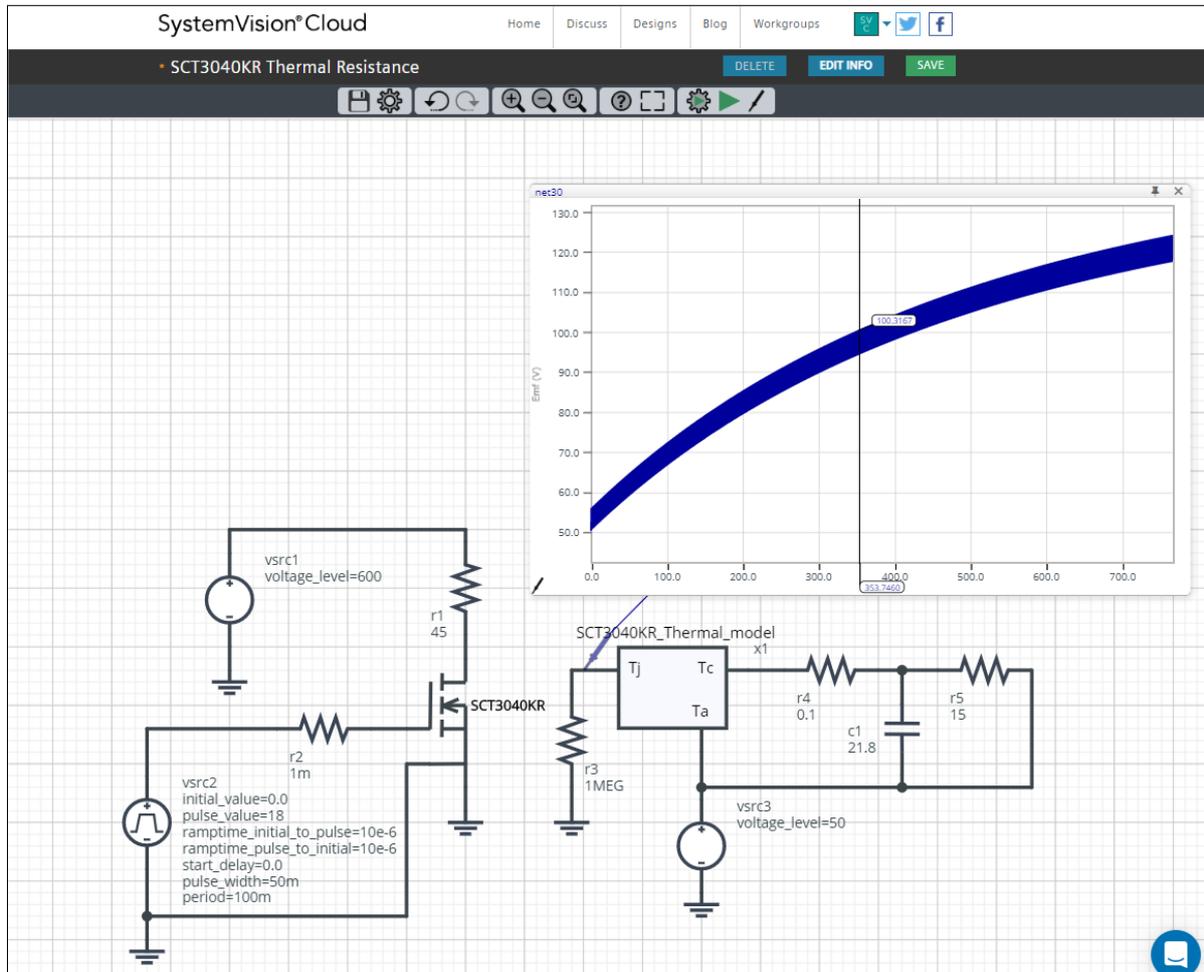
Calculate T_J with the following equation.

$$T_J = T_A + \Delta T_1 + \Delta T_2 \quad [^{\circ}\text{C}]$$

T_A : Ambient temperature [°C]

Calculation example 4

If the variation in the power loss is complicated, the junction temperature may be calculated with a simulation using a thermal model. For more details, refer to Application Note [“How to Use Thermal Models”](#).



Example of simulation using thermal model

Notes

- 1) The information contained herein is subject to change without notice.
- 2) Before you use our Products, please contact our sales representative and verify the latest specifications :
- 3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.
Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Products beyond the rating specified by ROHM.
- 4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
- 5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
- 6) The Products specified in this document are not designed to be radiation tolerant.
- 7) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
- 8) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
- 9) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
- 10) ROHM has used reasonable care to ensure the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
- 11) Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
- 12) When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
- 13) This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations.
More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

<http://www.rohm.com/contact/>